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PRIMARY CHARACTERISTICS							
V _{CES}	600 V						
$V_{CE(on)}$ typical at I _C = 50 A	1.41 V						
I _C at T _C = 25 °C	121 A						
Speed	30 kHz to 100 kHz						
Package	MTP						
Circuit configuration	Half bridge						

"Half Bridge" IGBT MTP, 121 A

FEATURES

- Trench IGBT technology
- HEXFRED[®] antiparallel diodes with ultrasoft reverse recovery
- Very low conduction and switching losses
- Optional SMD thermistor (NTC)
- Very low junction to case thermal resistance
- UL approved file E78996
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- Optimized for welding, UPS and SMPS applications
- · Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- Very low stray inductance design for high speed operation

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Collector to emitter voltage	V _{CES}		600	V			
Continuous collector current	1.	T _C = 25 °C	121				
Continuous collector current	IC	T _C = 117 °C	50				
Pulsed collector current	I _{CM}	$T_J = 150 \text{ °C}, t_p = 6 \text{ ms}, V_{GE} = 15 \text{ V}$	250	A			
Peak switching current	I _{LM}		76				
Diode continuous forward current	١ _F	T _C = 109 °C	34				
Peak diode forward current	I _{FM}		200				
Gate to emitter voltage	V _{GE}		± 20	V			
RMS isolation voltage	VISOL	Any terminal to case, t = 1 min	2500	v			
Maximum power dissinction	Б	T _C = 25 °C	305	w			
Maximum power dissipation	PD	T _C = 100 °C	122				

ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Collector to emitter breakdown voltage	V _{(BR)CES}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 0.4 \text{ mA}$	600	-	-	V		
		$V_{GE} = 15 \text{ V}, I_{C} = 50 \text{ A}$	-	1.41	1.64			
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 100 A	-	1.77	-	V		
		V_{GE} = 15 V, I _C = 50 A, T _J = 150 °C	-	1.46	-	v		
Gate threshold voltage	V _{GE(th)}	I _C = 1 mA	2.9	4.2	5.3			
Collector to amittar locking ourrent		$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 600 \text{ A}$	-	0.8	100			
Collector to emitter leaking current	ICES	V_{GE} = 0 V, I _C = 600 A, T _J = 150 °C	-	1980	-	μA		
	V _{FM}	$I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}$	-	1.58	1.8			
Diode forward voltage drop		$I_F = 50 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 150 ^\circ\text{C}$	-	1.49	-	V		
		I_F = 100 A, V_{GE} = 0 V, T_J = 25 $^\circ C$	-	1.9	-			
Gate to emitter leakage current	I _{GES}	$V_{GE} = \pm 20 V$	-	-	± 250	nA		

Pb-free

RoHS COMPLIANT

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SWITCHING CHARACTERISTICS (T_J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg	I _C = 50 A	-	239	-		
Gate to emitter charge (turn-on)	Q _{ge}	$V_{CC} = 520 \text{ V}$	-	33	-	nC	
Gate to collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V	-	70	-		
Turn-on switching loss	Eon	$I_{C} = 50 \text{ A}, V_{CC} = 480 \text{ V}, V_{GE} = 15 \text{ V}, R_{g} = 10 \Omega,$	-	1.09	-		
Turn-off switching loss	E _{off}	L = 500 µH energy losses include tail and diode reverse	-	0.37	-	mJ	
Total switching loss	E _{ts}	recovery, $T_J = 25 \text{ °C}$	-	1.46	-		
Turn-on switching loss	E _{on}	$I_{C} = 50 \text{ A}, V_{CC} = 480 \text{ V}, V_{GE} = 15 \text{ V}, R_{g} = 10 \Omega,$ $L = 500 \mu \text{H}$ energy losses include tail and diode reverse recovery, $T_{J} = 150 \text{ °C}$		1.46	-	mJ	
Turn-off switching loss	E _{off}			0.62	-		
Total switching loss	E _{ts}			2.08	-		
Input capacitance	C _{ies}	V _{GE} = 0 V V _{CC} = 25 V f = 1.0 MHz		6000	-		
Output capacitance	C _{oes}			100	-	pF	
Reverse transfer capacitance	C _{res}			22	-		
Diode reverse recovery time	t _{rr}		-	82	-	ns	
Diode peak reverse current	Irr	V _{CC} = 200 V, I _C = 50 A dI/dt = 200 A/µs	-	8.3	-	Α	
Diode recovery charge	Q _{rr}	αναι – 200 Ανμο	-	340	-	nC	
Diode reverse recovery time	t _{rr}	$V_{CC} = 200 \text{ V}, I_{C} = 50 \text{ A}$	-	137	-	ns	
Diode peak reverse current	Irr	dl/dt = 200 A/µs	-	12.7	-	Α	
Diode recovery charge	Q _{rr}	T _J = 125 °C	-	870	-	nC	

THERMISTOR SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Resistance	R ₀ ⁽¹⁾	T ₀ = 25 °C	-	30	-	kΩ		
Sensitivity index of the thermistor material	β (1)(2)	T ₀ = 25 °C T ₁ = 85 °C	-	4000	-	к		

Notes

 $^{(1)}$ T₀, T₁ are thermistor's temperatures

(2)
$$\frac{R_0}{R_1} = \exp\left[\beta\left(\frac{1}{T_0} - \frac{1}{T_1}\right)\right]$$
, temperature in Kelvin

THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Junction and storage temperature range	T _J , T _{Stg}		-40	-	150	°C		
Junction to case	R _{thJC}		-	-	0.41			
Diode	nthJC		-	-	0.8	°C/W		
Case to sink per module	R _{thCS}		-	0.06	-			
Clearance ⁽¹⁾		External shortest distance in air between 2 terminals	5.5	-	-			
Creepage ⁽¹⁾		Shortest distance along the external surface of the insulating material between 2 terminals	8	-	-	mm		
Mounting torque to heatsink		A mounting compound is recommended and the torque should be checked after 3 hours to allow for the spread of the compound. Lubricated threads.	3 ± 10 %		Nm			
Weight			66			g		

Note

⁽¹⁾ Standard version only i.e. without optional thermistor

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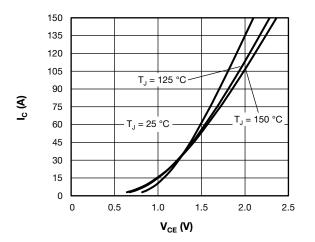


Fig. 1 - Typical Trench IGBT Output Characteristics, V_{GE} = 15 V

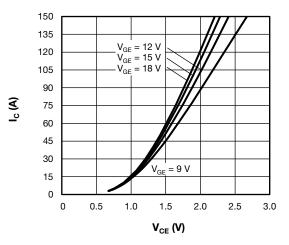


Fig. 2 - Typical Trench IGBT Output Characteristics, $T_{\rm J}$ = 125 $^\circ C$

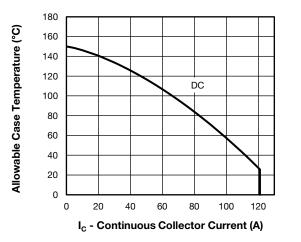


Fig. 3 - Maximum Trench IGBT Continuous Collector Current vs. Case Temperature

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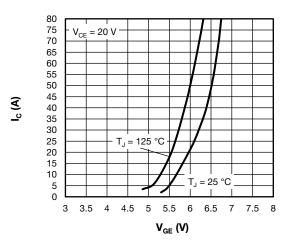


Fig. 4 - Typical Trench IGBT Transfer Characteristics

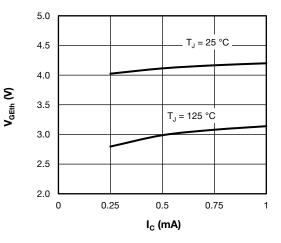


Fig. 5 - Typical Trench IGBT Gate Threshold Voltage

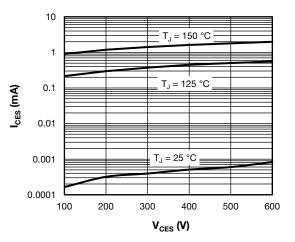


Fig. 6 - Typical Trench IGBT Zero Gate Voltage Collector Current

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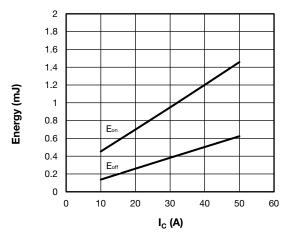


Fig. 7 - Typical Trench IGBT Energy Loss vs. I_C (with Antiparallel Diode) $T_J = 150 \text{ °C}, V_{CC} = 600 \text{ V}, R_q = 10 \Omega, V_{GE} = +15 \text{ V/-}15 \text{ V}, L = 500 \mu\text{H}$

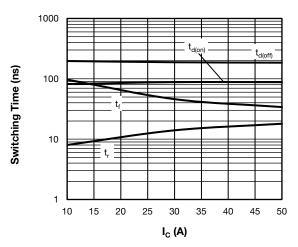
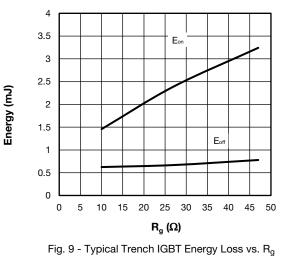
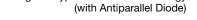


Fig. 8 - Typical Trench IGBT Switching Time vs. I_C (with Antiparallel Diode) T_J = 150 °C, V_{CC} = 300 V, R_g = 10 Ω , V_{GE} = +15 V/-15 V, L = 500 μ H





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 T_J = 150 °C, V_{CC} = 600 V, I_C = 50 A, V_{GE} = +15 V/-15 V, L = 500 μH

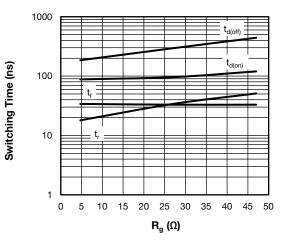


Fig. 10 - Typical Trench IGBT Switching Time vs. R_g (with Antiparallel Diode) T_J = 150 °C, V_{CC} = 600 V, I_C = 50 A, V_{GE} = +15 V/-15 V, L = 500 μH

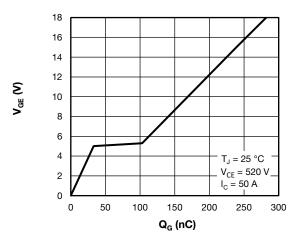


Fig. 11 - Typical Trench IGBT Gate Charge vs. Gate to Emitter Voltage

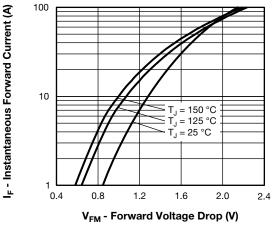


Fig. 12 - Typical Diode Forward Characteristics

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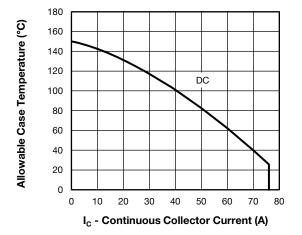


Fig. 13 - Maximum Diode Continuous Collector Current vs. **Case Temperature**

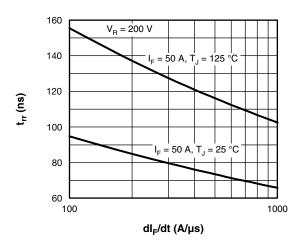


Fig. 14 - Typical Antiparallel Diode Reverse Recovery Time vs. dl_F/dt

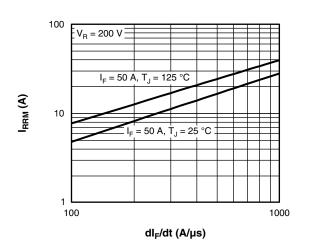


Fig. 15 - Typical Antiparallel Diode Reverse Recovery Current vs. dl_F/dt

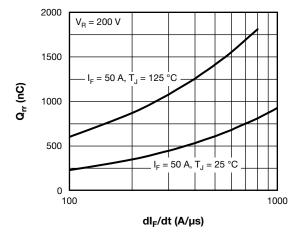


Fig. 16 - Typical Antiparallel Diode Reverse Recovery Charge vs. dl_F/dt

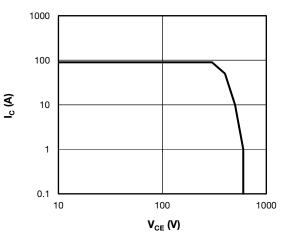
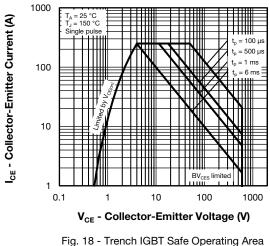
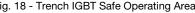


Fig. 17 - Trench IGBT Reverse BIAS SOA $T_{J} = 150 \text{ °C}, I_{C} = 90 \text{ A}, R_{g} = 10 \Omega, V_{GE} = +15 \text{ V/0 V}, V_{CC} = 300 \text{ V}, V_{p} = 600 \text{ V}$





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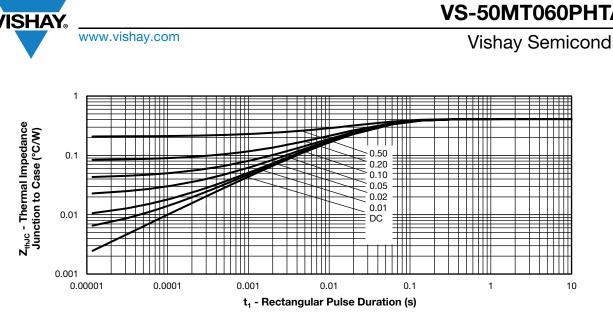


Fig. 19 - Maximum Trench IGBT Thermal Impedance Z_{thJC} Characteristics

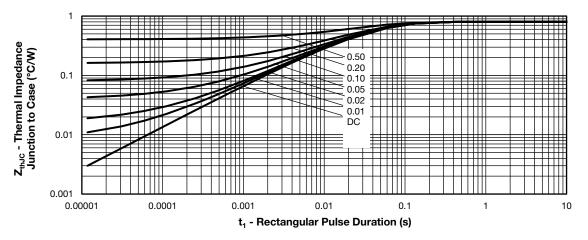


Fig. 20 - Maximum Diode Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code	VS-	50	МТ	060	Ρ	н	т	Α	PbF
	1	2	3	4	5	6	7	8	9
	1 - 2 -		•	emicono ating (50			t		
	3 -			part nu		,			
	4 -	V	oltage r	ating (06	60 = 600) V)			
	5 -	S	peed / t	ype (P =	= Trench	IGBT)			
	6 -	C	ircuit co	onfigurat	tion (H =	half br	idge)		
	7 -	Т	= therm	nistor					
	8 -	$A = AI_2O_3$ substrate							
	9 -	L	ead (Pb)-free					

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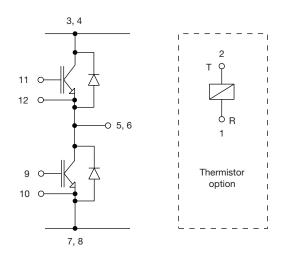
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CIRCUIT CONFIGURATION



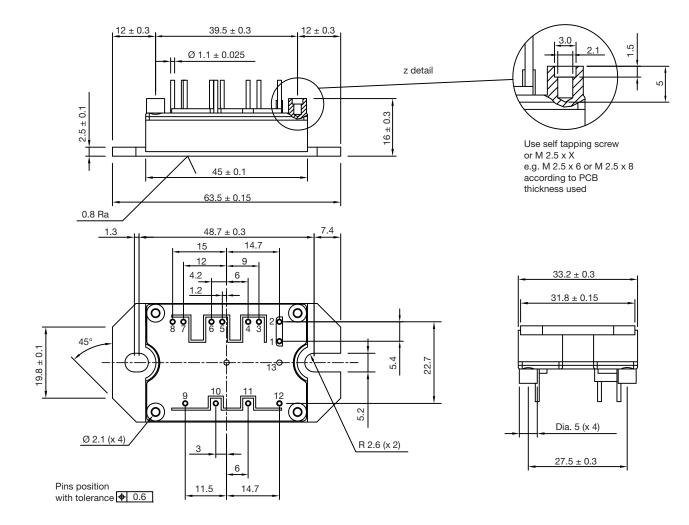
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95175			



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MTP

DIMENSIONS in millimeters



Note

· Unused terminals are not assembled in the package



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